

Structure : Silicon Monolithic Integrated Circuit  
 Product Name : Power Driver IC for CDs/DVDs

Device Name : **BD7931F**

- Features :
- High D-range loading driver with MOS outputs ( $R_{on} = 1.0\Omega$ )
  - Provided with a loading driver voltage setting terminal
  - A built-in thermal shutdown circuit installed.
  - SOP-8 package

○ ABSOLUTE MAXIMUM RATINGS ( $T_a=25^\circ\text{C}$ )

Parameter	Symbol	Limits	Unit
Power Supply Voltage	Vcc	15	V
Power Dissipation	Pd	0.69 *1	W
Operating Temperature Range	Topr	-40 to +85	°C
Storage Temperature Range	Tstg	-55 to +150	°C

\*1 When mounted on the glass/epoxy board with the size: 70 mm×70 mm, the thickness: 1.6 mm, and the rate of copper foil occupancy area: 3% or less.  
 Over  $T_a=25^\circ\text{C}$ , derating at the rate of 5.5mW/°C.

○ OPERATING POWER SUPPLY VOLTAGE RANGE

Parameter	Symbol	MIN	TYP	MAX	Unit
Power Supply Voltage	Vcc	4.5	8	14	V

This product has not been checked for the strategic materials (or service) defined in the Foreign Exchange and Foreign Trade Control Law of Japan so that a verification work is required before exporting it.

Not designed for radiation resistance.

○ ELECTRIC CHARACTERISTICS

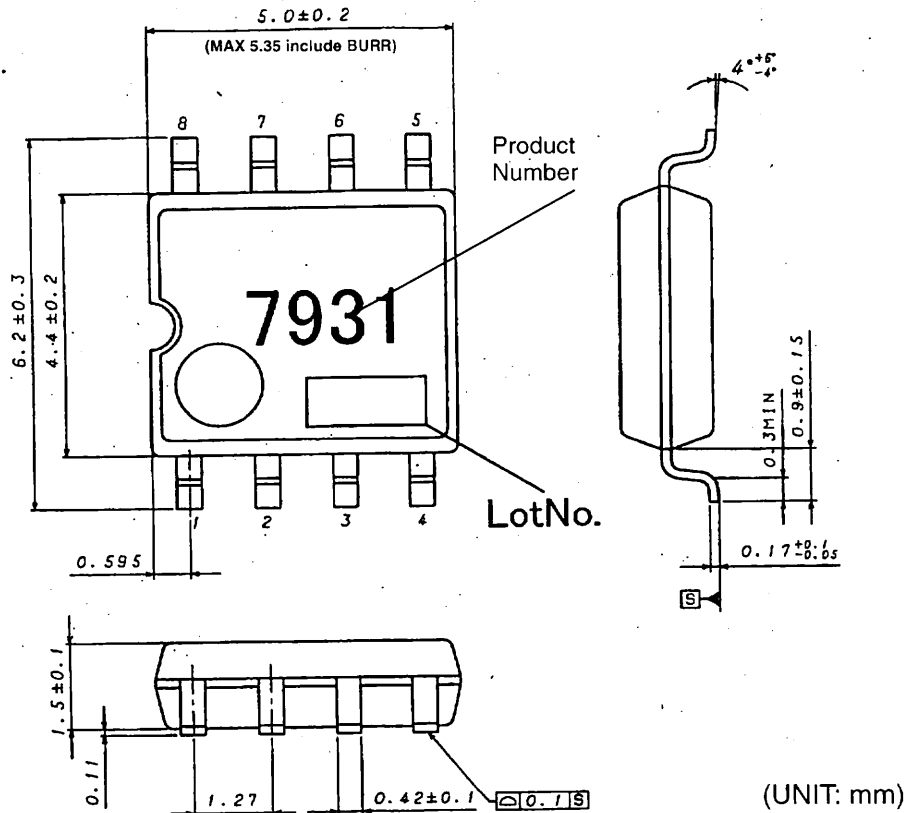
(Ta=25°C, Vcc=8V, unless otherwise noted.)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit	Condition
Quiescent Circuit Current (Vcc)	ICC1	-	0	5	μA	
Circuit Current in Operation (Vcc)	ICC2	-	1.1	2.2	mA	FIN=5V, RIN=0V
Circuit Current in Brake Mode (Vcc)	ICC3	-	0.8	1.6	mA	FIN=RIN=5V
<Loading Driver>						
Output Offset Voltage	VOFSL	-35	0	+35	mV	In brake mode
Input Terminal Threshold Voltage H	VIH	2.0	-	Vcc	V	
Input Terminal Threshold Voltage L	VIL	GND	-	0.5	V	
ON Resistance	RON	-	1.0	1.8	Ω	Io=500mA
Voltage Gain (Loading)	GVLD	4.0	6.0	8.0	dB	*1
Difference between positive and negative voltage gains (Loading)	ΔGVLD	-2.0	0	2.0	dB	
Input Terminal Inflow Current	IINL	-	165	250	μA	FIN=5V, RIN=5V
LDCONT Terminal Outflow Current	ILDC	-	-	300	nA	CONT=5V

\*1. Assuming that

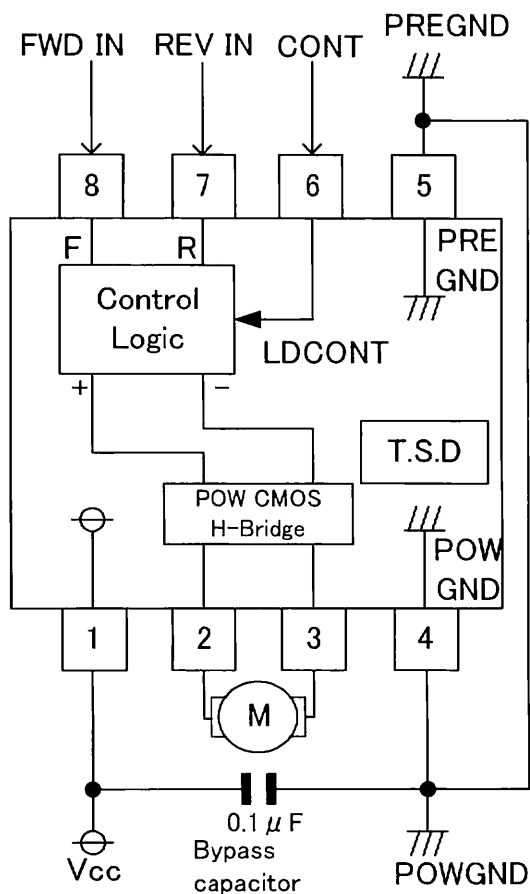
V<sub>01</sub> is the potential between the outputs when CONT=1V,  
 V<sub>02</sub> is the potential between the outputs when CONT=3.5V, and  
 GVLD=20log|(V<sub>02</sub>- V<sub>01</sub>)/2.5|

○ OUTLINE DIMENSIONS



(UNIT: mm)

○ APPLICATION CIRCUIT DIAGRAM



○ PIN Description

No.	Pin name	Description	No.	Pin name	Description
1	Vcc	Power Supply Voltage	5	GND_S	PREGND
2	OUT+	Loading driver FWD output	6	CONT	Loading driver voltage setting terminal
3	OUT-	Loading driver REV output	7	RIN	Loading driver REV input
4	GND	POWGND	8	FIN	Loading driver FWD input

○ CAUTIONS ON USE

(1) The loading driver functions following to the logic in the table below:

INPUT		OUTPUT		Function
FWD	REV	OUT+	OUT-	
L	L	Hi-Z	Hi-Z	High Impedance
L	H	L	H	Reverse mode
H	L	H	L	Forward mode
H	H	L	L	Brake mode

Although the output voltage can be changed by the input voltage through the LDCONT terminal (gain 6dB Typ.), it never exceeds the maximum output voltage restricted by the power supply voltage even if applying a voltage much larger than the normal value.

- (2) Make sure that the short circuit between the driver output and the power supply; or the driver output and GND must be avoided. Also the output terminals must not be short-circuited.
- (3) About absolute maximum ratings  
Exceeding the absolute maximum ratings, such as the applied voltage or the operating temperature range, may cause permanent device damage. As these cases cannot be limited to the broken short mode or the open mode, if a special mode where the absolute maximum ratings may be exceeded is assumed, it is recommended to take mechanical safety measures such as attaching fuses.
- (4) About power supply lines  
As a measure against the back current regenerated by a counter electromotive force of the motor, a capacitor to be used as a regenerated-current path can be installed between the power supply and GND and its capacitance value should be determined after careful check that any problems, for example, a leak capacitance of the electrolytic capacitor at low temperature, are not found in various characteristics.
- (5) About GND potential  
The electric potential of the GND terminal must be kept lowest in the circuitry at any operation states.
- (6) About thermal design (Thermal shutdown: TSD)  
With consideration of the power dissipation (Pd) under conditions of actual use, a thermal design provided with an enough margin should be done.
- (7) About operations in a strong electric field  
When used in a strong electric field, note that a malfunction may occur.
- (8) ASO  
When using this IC, the output Tr must be set not to exceed the values specified in the absolute maximum ratings and ASO.
- (9) Thermal shutdown circuit (Thermal shutdown: TSD)  
This IC incorporates a thermal shutdown circuit (TSD circuit). When the chip temperature reaches the value shown below, the coil output to the motor will be set to open.  
The thermal shutdown circuit is designed only to shut off the IC from a thermal runaway and not intended to protect or guarantee the entire IC functions.  
Therefore, users cannot assume that the TSD circuit once activated can be used continuously in the subsequent operations.

TSD ON Temperature [°C] (typ.)	Hysteresis Temperature [°C] (typ.)
175	25

- (10) About earth wiring patterns  
When a small signal GND and a large current GND are provided, it is recommended that the large current GND pattern and the small signal GND pattern should be separated and grounded at a single point of the reference point of the set in order to prevent the voltage of the small signal GND from being affected by a voltage change caused by the resistance of the pattern wiring and the large current.
- (11) Make sure that the GND wiring patterns of the external components will not change, too.  
This IC is a monolithic IC which has a P<sup>+</sup> isolations and P substrate to isolate elements each other.

This P layer and an N layer in each element form a PN junction to construct various parasitic elements. Due to the IC structure, the parasitic elements are inevitably created by the potential relationship. Activation of the parasitic elements can cause interference between circuits and may result in a malfunction or, consequently, a fatal damage. Therefore, make sure that the IC must not be used under conditions that may activate the parasitic elements, for example, applying the lower voltage than the ground level (GND, P substrate) to the input terminals. In addition, do not apply the voltage to input terminals without applying the power supply voltage to the IC. Also while applying the power supply voltage, the voltage of each input terminal must not be over the power supply voltage, or within the guaranteed values in the electric characteristics.

### Notes

- No technical content pages of this document may be reproduced in any form or transmitted by any means without prior permission of ROHM CO.,LTD.
- The contents described herein are subject to change without notice. The specifications for the product described in this document are for reference only. Upon actual use, therefore, please request that specifications to be separately delivered.
- Application circuit diagrams and circuit constants contained herein are shown as examples of standard use and operation. Please pay careful attention to the peripheral conditions when designing circuits and deciding upon circuit constants in the set.
- Any data, including, but not limited to application circuit diagrams information, described herein are intended only as illustrations of such devices and not as the specifications for such devices. ROHM CO.,LTD. disclaims any warranty that any use of such devices shall be free from infringement of any third party's intellectual property rights or other proprietary rights, and further, assumes no liability of whatsoever nature in the event of any such infringement, or arising from or connected with or related to the use of such devices.
- Upon the sale of any such devices, other than for buyer's right to use such devices itself, resell or otherwise dispose of the same, no express or implied right or license to practice or commercially exploit any intellectual property rights or other proprietary rights owned or controlled by
- ROHM CO., LTD. is granted to any such buyer.
- Products listed in this document are no antiradiation design.

The products listed in this document are designed to be used with ordinary electronic equipment or devices (such as audio visual equipment, office-automation equipment, communications devices, electrical appliances and electronic toys).

Should you intend to use these products with equipment or devices which require an extremely high level of reliability and the malfunction of which would directly endanger human life (such as medical instruments, transportation equipment, aerospace machinery, nuclear-reactor controllers, fuel controllers and other safety devices), please be sure to consult with our sales representative in advance.

#### About Export Control Order in Japan

Products described herein are the objects of controlled goods in Annex 1 (Item 16) of Export Trade Control Order in Japan.

In case of export from Japan, please confirm if it applies to "objective" criteria or an "informed" (by MITI clause) on the basis of "catch all controls for Non-Proliferation of Weapons of Mass Destruction.

Thank you for your accessing to ROHM product informations.  
More detail product informations and catalogs are available,  
please contact your nearest sales office.

Please contact our sales offices for details ;

U.S.A / San Diego	TEL : +1(858)625-3630	FAX : +1(858)625-3670
Atlanta	TEL : +1(770)754-5972	FAX : +1(770)754-0691
Dallas	TEL : +1(972)312-8818	FAX : +1(972)312-0330
Germany / Dusseldorf	TEL : +49(2154)9210	FAX : +49(2154)921400
United Kingdom / London	TEL : +44(1)908-282-666	FAX : +44(1)908-282-528
France / Paris	TEL : +33(0)1 56 97 30 60	FAX : +33(0) 1 56 97 30 80
China / Hong Kong	TEL : +852(2)740-6262	FAX : +852(2)375-8971
Shanghai	TEL : +86(21)6279-2727	FAX : +86(21)6247-2066
Dilian	TEL : +86(411)8230-8549	FAX : +86(411)8230-8537
Beijing	TEL : +86(10)8525-2483	FAX : +86(10)8525-2489
Taiwan / Taipei	TEL : +866(2)2500-6956	FAX : +866(2)2503-2869
Korea / Seoul	TEL : +82(2)8182-700	FAX : +82(2)8182-715
Singapore	TEL : +65-6332-2322	FAX : +65-6332-5662
Malaysia / Kuala Lumpur	TEL : +60(3)7958-8355	FAX : +60(3)7958-8377
Philippines / Manila	TEL : +63(2)807-6872	FAX : +63(2)809-1422
Thailand / Bangkok	TEL : +66(2)254-4890	FAX : +66(2)256-6334

Japan /  
(Internal Sales)

Tokyo	2-1-1, Yaesu, Chuo-ku, Tokyo 104-0082	TEL : +81(3)5203-0321	FAX : +81(3)5203-0300
Yokohama	2-4-8, Shin Yokohama, Kohoku-ku, Yokohama, Kanagawa 222-8575	TEL : +81(45)476-2131	FAX : +81(45)476-2128
Nagoya	Dainagayo Building 9F 3-28-12, Meieki, Nakamura-ku, Nagoya, Aichi 450-0002	TEL : +81(52)581-8521	FAX : +81(52)561-2173
Kyoto	579-32 Higashi Shiokouji-cho, Karasuma Nishi-iru, Shiokoujidori, Shimogyo-ku, Kyoto 600-8216	TEL : +81(75)311-2121	FAX : +81(75)314-6559

(Contact address for overseas customers in Japan)

Yokohama	TEL : +81(45)476-9270	FAX : +81(045)476-9271
----------	-----------------------	------------------------